GF Measurement & Control

# Unique spatial and contrast resolution on a wide sample range phoenix nanotom m 180 kV / 15 W X-ray nanoCT<sup>®</sup> system for high-resolution analysis and 3D metrology





nanoCT® of TSVs in an electronic package. The voids in the copper filling are clearly visible.

3D volume slice of an AlMg5Si7 alloy (Ø 350 µm): Fe-aluminides and Ma\_Siphases.



3D metrology image of an injection molded part showing feature details.

### Key features & benefits

- Unique temperature stabilized digital GE DXR detector (3,072 x 2,400 pixels) for a high dynamic range > 10,000 : 1 and up to 4 times faster data acquisition at the same high image quality level
- Granite-based manipulator for high stability
- Max. sample size 240 mm Ø x 250 mm in height
- New open 180 kV / 15 W high-power nanofocus Xray tube with down to 200 nm detail detectability, optimized for long-term stability
- diamond window for extremely high focal spot stability and up to 2 times faster data acquisition at the same high image quality level
- Down to 300 nm minimum voxel size
- Optimized ease of use due to intelligent system design and advanced phoenix datos x CT software
- 3D metrology package with temperature stabilized cabinet and high accuracy direct measuring system





## **phoenix nanotom m** Versatile 3D computed tomography system

High-resolution computed tomography (CT) has become a powerful inspection tool for a wide range of industrial and scientific inspection and metrology applications such as non-destructive structure and failure analysis as well as for quality assurance or production control. With its 180 kV / 15 W ultra high performance nanofocus X-ray tube, precision mechanics and advanced software modules, the phoenix nanotom m is the inspection solution for a wide range of 3D CT applications. Once scanned, the fully three dimensional CT information allows many possibilities for analysis, e.g. non-destructive visualization of slices, arbitrary sectional views, or automatic pore analysis. Since the whole geometry of the object is scanned, precise and reproducible 3D measurements of complex objects and even the automatic generation of first article inspection reports within an hour are possible.



3D nanoCT<sup>®</sup> evaluation of artificial bone (ceramics matrix with aluminium coating)

### nanoCT<sup>®</sup> – closest to synchrotron CT

With its special design, the nanotom m provides focal spot sizes in the submicron range. Smaller focal spots ensure very little geometric unsharpness and therefore improved image resolution. And due to the new high dynamic range GE DXR detector the system offers long-term stable and optimized image quality.

In pursuit of high-resolution images, the potential, convenience and economy of nanoCT can compete in many application fields with limited available synchrotron facilities, e.g.:

- Materials science
- Micro-engineering
- Electronics
- Life sciences
- Geosciences and much more



CAD variance analysis and measurement of 5 features of an injection molded part

Especially if complex parts with hidden or difficult accessible surfaces have to be measured, CT offers big advantages in comparison with conventional tactile or optical coordinate measuring machines (CMMs). With its optimized 3D metrology package, the phoenix nanotom m includes all essential features for CT with extremely high accuracy and reproducibility:

**3D metrology with high-resolution CT** 

- Temperature stabilized cabinet
- High accuracy direct measuring system
- Vibration insulation of the manipulator
- Temperature stabilized GE DXR detector for brilliant image quality
- Long-term stability optimized X-ray tube with diamond|window reduction of artefacts
- 2 calibration objects
- phoenix datos|x software "click & measure|CT" and "metrology"

# phoenix datos x advanced CT software

### Fully automated data acquisition and volume processing

With datos|x, the entire CT process chain can be fully automated. This minimizes operator time and influence, while highly increasing the repeatability and reproducibility of CT results. Once the appropriate setup is programmed, the whole scan and reconstruction process incl. volume optimization features (e.g. automatic beam hardening correction) or surface extraction can be fully automated. Furthermore, 3D failure analysis or metrology tasks like generation of first article inspection reports can be executed automatically.

#### Precise, reliable and fast CT results

By using phoenix datos|x CT software, 3D metrology and failure analysis with phoenix|x-ray CT systems becomes as fast and easy as never before

- click & measure|CT: Fully automated data acquisition and volume processing – insert sample, start CT scan, check results
- Reproducible high precision 3D metrology and failure analysis tasks performed with a minimum of operator training
- Significant reduction of required operator time by factor of up to 5
- Wide spectrum of modules for ease of use and accurate CT results
- Accelerated sample throughput due to batch CT scans and up to 9 times faster volume reconstruction



Intuitive graphical user interface for easy usage and a fast learning curve due to clear display of CT results in 2D axis views and 3D render mode.

### phoenix nanotom m - Your Advantages

- Unique spatial and contrast resolution on a wide sample range from small material to medium sized plastic samples covering 3 orders of magnitude (0.25 mm to 250 mm sample size)
- Optimized 3D metrology package for stable acquisition conditions, fast reconstruction within minutes and reproducible measurement results
- Extremely high image quality due to unique temperature stabilized GE DXR detector (3,072 × 2,400 pixels) with a high dynamic range > 10,000 : 1
- Max. sample size 240 mm Ø x 250 mm in height and 3 kg (6.6 lbs.) in weight
- Automatic and continuous adjustment of the magnification
- Optimized ease of use due to system design and advanced phoenix datos|x CT software



New tube design optimized for long-term stability

### Technical Specifications & Configurations





	phoenix nanotom s	phoenix nanotom m
X-ray tube type	Proprietary open high-power nanofocus X-ray tube, optimized for long-term stability	
	Optional X-ray tube cooling	Internal X-ray tube cooling
Max. voltage / power	180kV/15W	
Target	Tungsten on beryllium (optional tungsten on CVD diamond)	Tungsten on CVD diamond for up to 2 times faster data acquisition at the same high image quality level
	Transmission target type, rotatable for multiple use (other target materials, e.g. molybdenum on request)	
Filament	Tungsten hairpin, pre-adjusted plug-in cartridges for fast and easy exchange	
Geom. magnification (3D)	1.7×-250×	1.5×-300×
Detail detectability	Down to 200 nm (0.2 microns)	Down to 200 nm (0.2 microns)
Min. voxel size	Down to 500 nm (0.5 microns)	Down to 300 nm (0.3 microns)
Detector type	High-Contrast Detector HCD 120-50, 12 bit / 16 bit, 3 x virtual detector enlargement (max. 6,900 pixel detector width)	Temperature-stabilized high dynamic GE DXR, 14 bit / 16 bit, 1.5 × detector enlargement (max. 4,600 pixel detector width)
Pixels	2,300×2,300	3,072×2,400
Pixel size	50 µm	100 µm
Manipulation	Granite based 5-axes manipulator with vibration insulation, precision rotation table on air bearings	
Variable focus detector distance	from 200 mm to 500 mm	from 220 mm to 600 mm
Max. sample diameter	<1mm to 120mm	<1mm to 240mm
Max. sample height/weight	150 mm / 2 kg (4.4 lbs.)	250 mm/3 kg (6.6 lbs.)
Sample travel length Y/Z	150 mm/300 mm	250 mm/400 mm
Rotation	0° - 360° x n	
System dimensions	1,630 mm x 1,432 mm x 740 mm (64.2" x 56.3" x 29.1")	1,980 mm x 1,600 mm x 925 mm (78" x 63" x 36.4")
System weight	Appr. 1,300 kg / 2,870 lbs.	Appr. 1,900 kg / 4,190 lbs.
Optional 3D metrology bundle		Temperature stabilized cabinet, high accuracy direct measuring system, calibration object, datos x module packages "metrology" and "click & measure CT"
Software	phoenix datos x 3D computed tomography acquisition and reconstruction software. Different 3D evaluation software packages for 3D metrology, failure or structure analysis on request.	
CT reconstruction	phoenix datos velo CT speed (2 GPUs)	phoenix datos velo CT high-speed (5 GPUs)
Basic datos x modules	auto ROI, sector scan, fast scan, multi scan, multi volume reconstruction, agc module - automatic geometry calibration, bhc+ module - automatic beam hardening correction, rar module - ring artefact reduction,	
Optional modules	datos x module package 3D "metrology", datos x module package "click & measure CT"	
Optional advanced sample manipulation	Manual XY highly accurate positioning table, tensile & compression testing stage system, coolstage specimen cooling unit Motorized XY-table with two linear axes	
Radiation protection	The radiation safety cabinet is a full protective installation without type approval according to the German RöV, French NFC 74 100 and the US Performance Standard 21 CFR 1020.40. For system operation, other official licenses may be necessary.	



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